

Bits	Search Text	DBs	Time Stamp	Comments
1 752	257/10,11.ccls. 439/20.ccls.	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2004/12/23 11:21	
2 1	S1 and S2	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:05	
3 23	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode)	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:10	
4 5	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode) and tension	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:06	
5 4	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode) and (thermal2 adj (expansion or expand or expanding))	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:07	
6 2	"5710483".pn.	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2004/12/23 11:41	
7 23	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode)	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:05	
8 756	257/10,11.ccls. 439/20.ccls.	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:05	
9 0	S7 and S8 and @pd>"20041223"	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:06	
10 0	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode) and @pd>"20041223"	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:06	
11 0	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode) and tension and @pd>"20041223"	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:07	
12 0	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode) and (thermal2 adj (expansion or expand or expanding)) and @pd>"20041223"	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:07	
13 1	S7 and S8	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:07	
14 1	(mesh adj grid) and (electron adj emission) and field and (gate adj electrode) and tensile	US-PGFUS: USPAT; EPO: JPO: DERMENT; IBM_IDB	2005/04/26 13:10	

EAST 4/26/05